

QUADRUPLE 3-STATE BUFFERS OE LOW

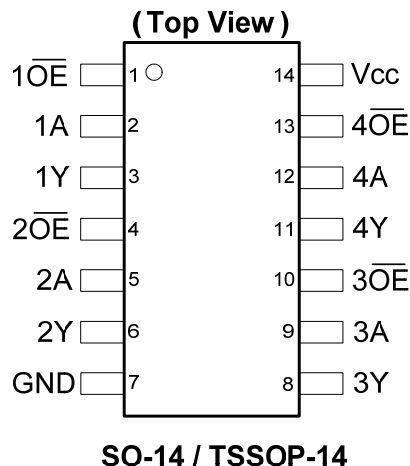
Description

The 74HC125 provides provides four independent buffer gates with 3-state outputs. Each buffer has a separate enable pin that if driven with a high logic level places the corresponding output in the high impedance state. The device is designed for operation with a power supply range of 2.0V to 6.0V.

Features

- Wide Supply Voltage Range from 2.0V to 6.0V
- Sinks or sources 4mA at $V_{CC} = 4.5V$
- CMOS low power consumption
- Schmitt Trigger Action at All Inputs
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Range of Package Options SO-14 and TSSOP-14
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Pin Assignments



Applications

- General Purpose Logic
- Wide array of products such as:
 - PCs, Networking, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, CD/DVD ROM
 - TV, DVD, DVR, Set Top Box

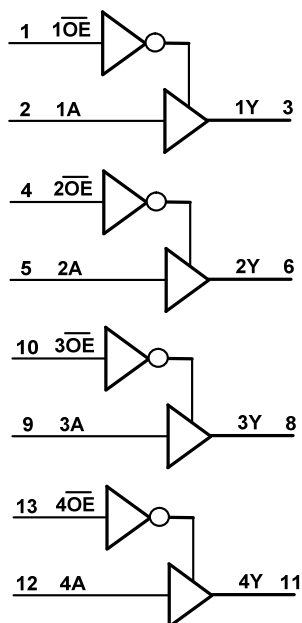
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|------------------|--------------------------------|
| 1 | $\overline{1OE}$ | Data Enable Input (active low) |
| 2 | 1A | Data Input |
| 3 | 1Y | Data Output |
| 4 | $\overline{2OE}$ | Data Enable Input (active low) |
| 5 | 2A | Data Input |
| 6 | 2Y | Data Output |
| 7 | GND | Ground |
| 8 | 3Y | Data Output |
| 9 | 3A | Data Input |
| 10 | $\overline{3OE}$ | Data Enable Input (active low) |
| 11 | 4Y | Data Outp |
| 12 | 4A | Data Input |
| 13 | $\overline{4OE}$ | Data Enable Input (active low) |
| 14 | V _{CC} | Supply Voltage |

Logic Diagram



Function Table

| Inputs | | Output |
|-----------------|---|--------|
| \overline{OE} | A | Y |
| L | H | H |
| L | L | L |
| H | X | Z |

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

| Symbol | Description | Rating | Unit |
|------------------|---|--------------|------|
| ESD HBM | Human Body Model ESD Protection | 2 | KV |
| ESD CDM | Charged Device Model ESD Protection | 1 | KV |
| ESD MM | Machine Model ESD Protection | 200 | V |
| V _{CC} | Supply Voltage Range | -0.5 to +7.0 | V |
| V _I | Input Voltage Range note 3) | -0.5 to +7.0 | V |
| I _{IK} | Input Clamp Current V _I < -0.5V or V _I > V _{CC} +0.5V | ±20 | mA |
| I _{OK} | Output Clamp Current V _O < -0.5V or V _O > V _{CC} +0.5V | ±20 | mA |
| I _O | Continuous Output Current -0.5V < V _O < V _{CC} +0.5V | +/- 25 | mA |
| I _{CC} | Continuous Current Through V _{CC} | 50 | mA |
| I _{GND} | Continuous Current Through GND | -50 | mA |
| T _J | Operating Junction Temperature | -40 to +150 | °C |
| T _{STG} | Storage Temperature | -65 to +150 | °C |
| P _{TOT} | Total Power Dissipation | 500 | mW |

- Notes:
- Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
 - Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded.

Recommended Operating Conditions (Note 6) (@T_A = +25°C, unless otherwise specified.)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------|------------------------------------|------------------------|-----|-----------------|------|
| V _{CC} | Supply Voltage | | 2.0 | 6.0 | V |
| V _I | Input Voltage | | 0 | V _{CC} | V |
| V _O | Output Voltage | | 0 | V _{CC} | V |
| Δt/ΔV | Input Transition Rise or Fall Rate | V _{CC} = 2.0V | | 625 | ns/V |
| | | V _{CC} = 4.5V | | 140 | |
| | | V _{CC} = 6.0V | | 85 | |
| T _A | Operating Free-Air Temperature | | -40 | +125 | °C |

Note: 6. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Symbol | Parameter | Test Conditions | V _{CC} | T _A = -40°C to +85°C | | T _A = -40°C to +125°C | | Unit |
|-----------------|---------------------------|--|-----------------|---------------------------------|-------|----------------------------------|------|------|
| | | | | Min | Max | Min | Max | |
| V _{IH} | High-level Input Voltage | | 2.0V | 1.5 | | 1.5 | | V |
| | | | 4.5V | 3.15 | | 3.15 | | |
| | | | 6.0V | 4.2 | | 4.2 | | |
| V _{IL} | Low-level Input voltage | | 2.0V | | 0.5 | | 0.5 | V |
| | | | 4.5V | | 1.35 | | 1.35 | |
| | | | 6.0V | | 1.8 | | 1.8 | |
| V _{OH} | High-level Output Voltage | I _{OH} = -20μA | 2.0V | 1.9 | | 1.9 | | V |
| | | I _{OH} = -20μA | 4.5V | 4.4 | | 4.4 | | |
| | | I _{OH} = -20μA | 6.0V | 5.9 | | 5.9 | | |
| | | I _{OH} = -4.0mA | 4.5V | 3.84 | | 3.7 | | |
| | | I _{OH} = -5.2mA | 6.0V | 5.34 | | 5.2 | | |
| V _{OL} | Low-level Output Voltage | I _{OL} = 20μA | 2.0V | | 0.1 | | 0.1 | V |
| | | I _{OL} = 20μA | 4.5V | | 0.1 | | 0.1 | |
| | | I _{OL} = 20μA | 6.0V | | 0.1 | | 0.1 | |
| | | I _{OL} = 4mA | 4.5V | | 0.33 | | 0.44 | |
| | | I _{OL} = 5.2mA | 6.0V | | 0.33 | | 0.44 | |
| I _{OZ} | Z State Leakage Current | V _O = 0 to 6.0V V _I = GND or 6.0V | 6.0V | | ± 5.0 | | ± 10 | μA |
| I _I | Input Current | V _I = GND to 5.5V | 6.0V | | ± 1 | | ± 1 | μA |
| I _{CC} | Supply Current | V _I = GND or V _{CC} , I _O = 0 | 6.0V | | 20 | | 40 | μA |

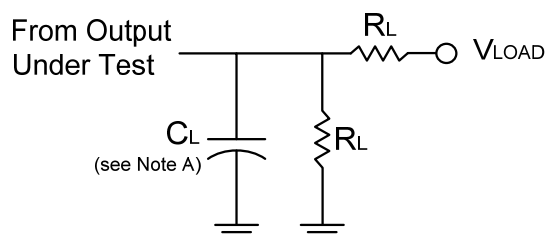
Switching Characteristics

| Symbol | Parameter | Test Conditions | V _{CC} | T _A = +25°C | | | -40°C to +85°C | -40°C to +125°C | Unit |
|------------------|--|------------------------------------|-----------------|------------------------|------|-----|----------------|-----------------|------|
| | | | | Min | Typ. | Max | Max | Max | |
| t _{PD} | Propagation Delay A _N to Y _N | Figure 1 C _L = 50 pF | 2.0V | — | 30 | 100 | 125 | 150 | ns |
| | | | 4.5V | — | 11 | 20 | 25 | 30 | |
| | | | 6.0V | — | 9 | 17 | 21 | 26 | |
| t _{EN} | Enable Time OE _N to Y _N | Figure 1 C _L = 50 pF | 2.0V | — | 41 | 125 | 155 | 190 | ns |
| | | | 4.5V | — | 15 | 25 | 31 | 38 | |
| | | | 6.0V | — | 12 | 21 | 26 | 32 | |
| t _{DIS} | Disable Time OE to Y _N | Figure 1 C _L = 50 pF | 2.0V | — | 41 | 125 | 155 | 190 | ns |
| | | | 4.5V | — | 15 | 25 | 31 | 38 | |
| | | | 6.0V | — | 12 | 21 | 26 | 32 | |
| t _t | Transition time | Figure 1 C _L = 50 pF | 2.0V | — | 14 | 60 | 75 | 90 | ns |
| | | | 4.5V | — | 5 | 12 | 15 | 18 | |
| | | | 6.0V | — | 4 | 10 | 13 | 15 | |

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

| Parameter | | Test Conditions | V _{CC} = 6V | Unit |
|-----------------|--|---|----------------------|------|
| | | | Typ | |
| C _{pd} | Power Dissipation Capacitance per Gate | f = 1MHz | 22 | pF |
| C _I | Input Capacitance | V _I = V _{CC} – or GND | 4 | pF |

Parameter Measurement Information



| TEST | Condition |
|-------------------------------|------------|
| t_{PLZ} (see Notes D and E) | V_{load} |
| t_{PZL} (see Notes D and F) | V_{load} |

| V_{CC} | Inputs | | V_M | V_{LOAD} | C_L | R_L | V_{Δ} |
|--------------|----------|------------|------------|-------------------|----------|--------------|-----------------|
| | V_I | t_r/t_f | | | | | |
| 2.0V to 6.0V | V_{CC} | $\leq 3ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 15,50 pF | 2 K Ω | 10% of V_{CC} |

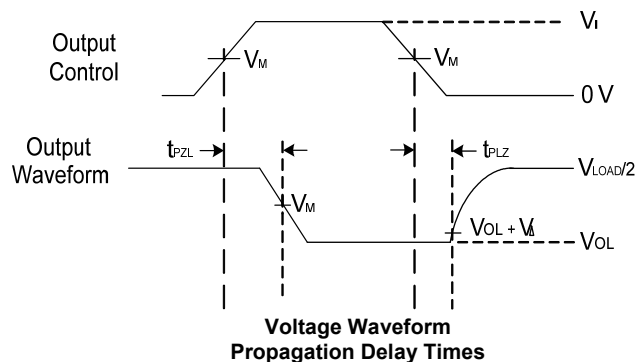
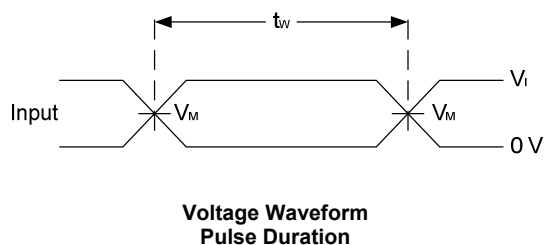
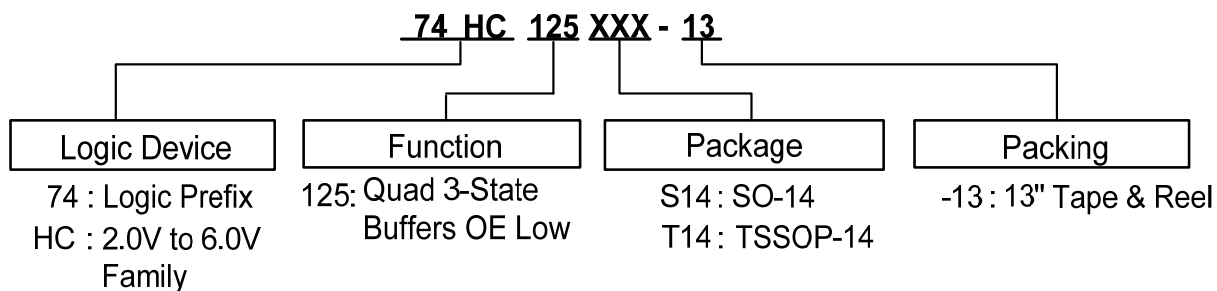


Figure 1 Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
 - C. The inputs are measured one at a time with one transition per measurement.
 - D. For the 3 state device t_{PLZ} and t_{PZL} are the same as t_{PD} .
 - E. t_{PZL} is measured at V_M .
 - D. t_{PLZ} is measured at $V_{OL} + V_{\Delta}$.

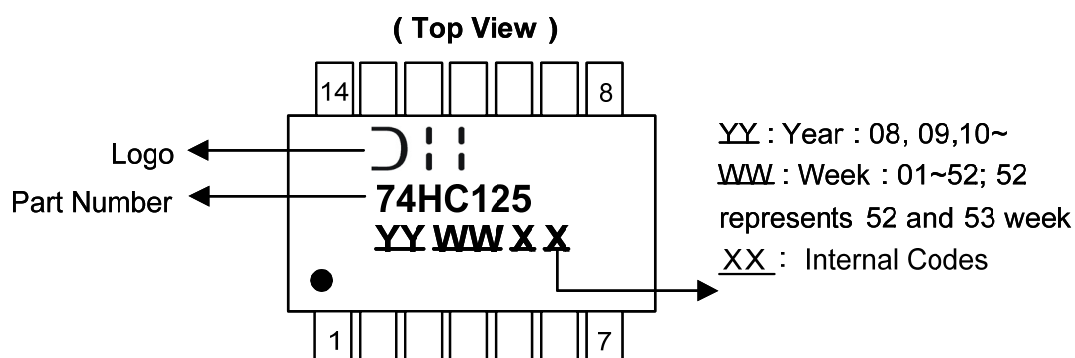
Ordering Information



| Device | Package Code | Packaging | 7" Tape and Reel | |
|---------------|--------------|-----------|------------------|--------------------|
| | | | Quantity | Part Number Suffix |
| 74HC125S14-13 | S14 | SO-14 | 2500/Tape & Reel | -13 |
| 74HC125T14-13 | T14 | TSSOP-14 | 2500/Tape & Reel | -13 |

Marking Information

(1) SO-14, TSSOP-14

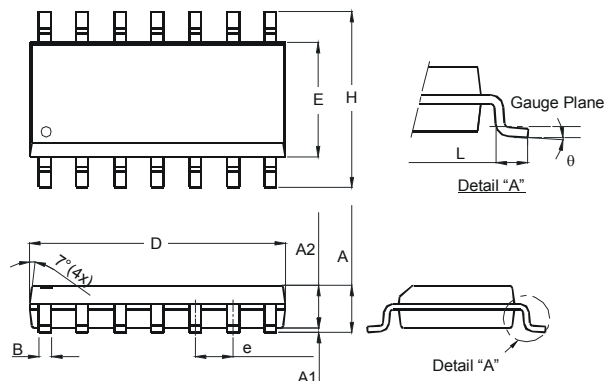


| Part Number | Package |
|-------------|----------|
| 74HC125S14 | SO-14 |
| 74HC125T14 | TSSOP-14 |

Package Outline Dimensions (All dimensions in mm.)

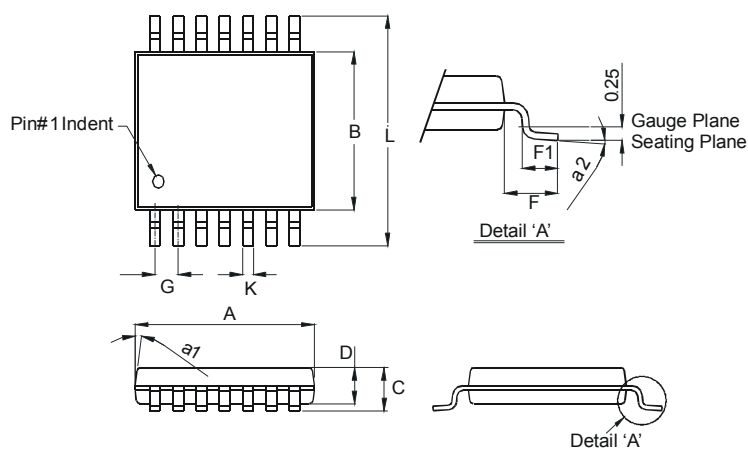
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

Package Type: SO-14



| SO-14 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| A | 1.47 | 1.73 |
| A1 | 0.10 | 0.25 |
| A2 | 1.45 Typ | |
| B | 0.33 | 0.51 |
| D | 8.53 | 8.74 |
| E | 3.80 | 3.99 |
| e | 1.27 Typ | |
| H | 5.80 | 6.20 |
| L | 0.38 | 1.27 |
| θ | 0° | 8° |
| All Dimensions in mm | | |

Package Type: TSSOP-14

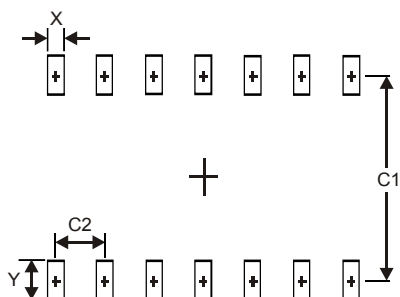


| TSSOP-14 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| a1 | 7° (4X) | |
| a2 | 0° | 8° |
| A | 4.9 | 5.10 |
| B | 4.30 | 4.50 |
| C | — | 1.2 |
| D | 0.8 | 1.05 |
| F | 1.00 Typ | |
| F1 | 0.45 | 0.75 |
| G | 0.65 Typ | |
| K | 0.19 | 0.30 |
| L | 6.40 Typ | |
| All Dimensions in mm | | |

Suggested Pad Layout

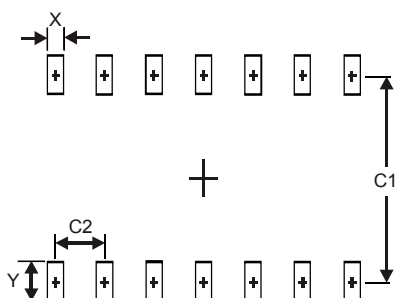
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.

Package Type: SO-14



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.60 |
| Y | 1.50 |
| C1 | 5.4 |
| C2 | 1.27 |

Package Type: TSSOP-14



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.45 |
| Y | 1.45 |
| C1 | 5.9 |
| C2 | 0.65 |

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